

**20V Dual N-Channel Enhancement Mode MOSFET****Description**

The PECN7222EMR uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch applications.

**General Features**

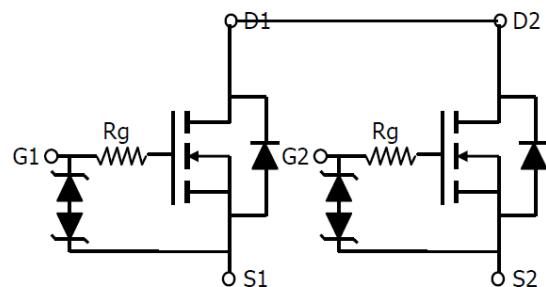
- ◆  $V_{DS} = 20V, ID = 6A$   
 $R_{DS(ON)} = 20m\Omega$  (typical) @  $VGS = 4.5V$   
 $R_{DS(ON)} = 24m\Omega$  (typical) @  $VGS = 2.5V$
- ◆ High power and current handling capability
- ◆ Lead free product is acquired
- ◆ Surface mount package
- ◆ ESD Protected up to 2kV HBM

**Application**

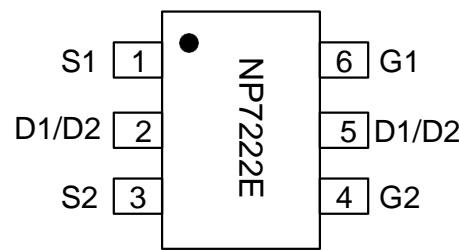
- ◆ Battery protection
- ◆ Load switch
- ◆ Power management

**Package**

- ◆ SOT23-6L

**Schematic diagram****Marking and pin assignment**

SOT23-6L  
(Topview)



NP: Natlinear Power

7222: Product No.

E: with ESD Protected

**Ordering Information**

Part Number	Storage Temperature	Package	Devices Per Reel
PECN7222EMR-G	-55°C to +150°C	SOT23-6L	3000

**Absolute Maximum Ratings (TA=25°C unless otherwise noted)**

parameter	symbol	limit	unit
Drain-source voltage	$V_{DS}$	20	V
Gate-source voltage	$V_{GS}$	$\pm 12$	V
Drain Current-Continuous (Silicon Limited)	$I_D$	6	A
		4	
Pulsed Drain Current (Package Limited)	$I_{DM}$	24	A
Maximum power dissipation	$P_D$	1.5	W
		1	
Operating junction Temperature range	$T_j$	-55—150	°C

**Electrical Characteristics** (TA=25°C unless otherwise noted)

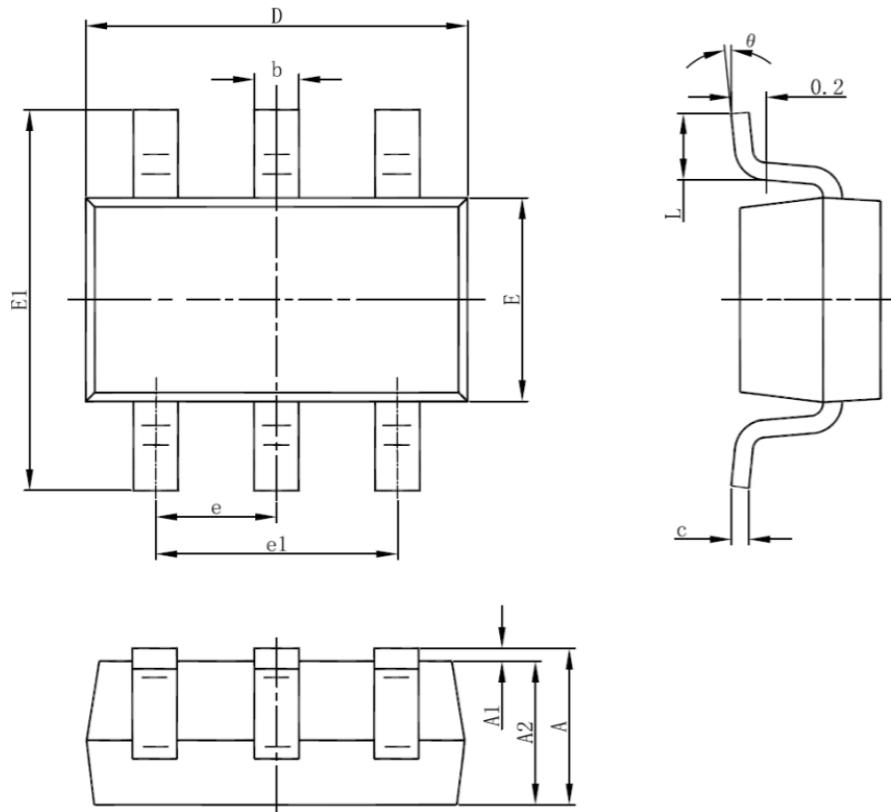
Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>OFF Characteristics</b>						
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	20	-	-	V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V	-	-	1	μA
Gate-body leakage	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±8V	-	-	±100	nA
		V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V			±5	μA
<b>ON Characteristics</b>						
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.5	0.65	1.2	V
Drain-source on-state resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =6A	-	20	26	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =5A	-	24	30	
Forward transconductance	g <sub>f</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =6A	-	10	-	S
<b>Dynamic Characteristics</b>						
Input capacitance	C <sub>ISS</sub>	V <sub>DS</sub> =10V ,V <sub>GS</sub> =0V f=1.0MHz	-	180	-	pF
Output capacitance	C <sub>OSS</sub>		-	95	-	
Reverse transfer capacitance	C <sub>RSS</sub>		-	18	-	
Gate resistance	R <sub>g</sub>	V <sub>DS</sub> =0V ,V <sub>GS</sub> =0V f=1.0MHz		2.7		k Ω
<b>Switching Characteristics</b>						
Turn-on delay time	t <sub>D(ON)</sub>	V <sub>DS</sub> =10V V <sub>GS</sub> =4.5V R <sub>L</sub> =10Ω R <sub>GEN</sub> =6Ω	-	60	-	ns
Rise time	t <sub>r</sub>		-	82	-	
Turn-off delay time	t <sub>D(OFF)</sub>		-	580	-	
Fall time	t <sub>f</sub>		-	243	-	
Total gate charge	Q <sub>g</sub>	V <sub>DS</sub> =10V,I <sub>D</sub> =6A V <sub>GS</sub> =4.5V	-	8.5	-	nC
Gate-source charge	Q <sub>gs</sub>		-	1.4	-	
Gate-drain charge	Q <sub>gd</sub>		-	3	-	

**Thermal Characteristics**

Thermal Resistance junction-to ambient	R <sub>th JA</sub>	100	°C/W
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## Package Information

- SOT23-6L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°